IP4283CZ10 series

ESD protection for ultra high-speed interfaces

Rev. 4 — 8 April 2013

Product data sheet

1. Product profile

1.1 General description

The devices are designed to protect high-speed interfaces such as High-Definition Multimedia Interface (HDMI), DisplayPort, external Serial Advanced Technology Attachment (eSATA) and Low-Voltage Differential Signaling (LVDS) interfaces against ElectroStatic Discharge (ESD).

The devices include four high-level ESD protection diode structures for ultra high-speed signal lines. They are available in three package variants: DFN2510-10 (SOT1165-1), DFN2510A-10 (SOT1176-1) and TSSOP10 (SOT552-1).

All signal lines are protected by a special diode configuration offering ultra low line capacitance of only 0.6 pF. These diodes provide protection to downstream components from ESD voltages up to ± 8 kV contact according to IEC 61000-4-2, level 4.

1.2 Features and benefits

- System ESD protection for HDMI, DisplayPort, eSATA and LVDS
- All signal lines with integrated rail-to-rail clamping diodes for downstream ESD protection of ±8 kV according to IEC 61000-4-2, level 4
- Matched 0.5 mm trace spacing
- Signal lines with ≤ 0.05 pF matching capacitance between signal pairs
- Line capacitance of only 0.6 pF for each channel
- Design-friendly 'pass-thru' signal routing

1.3 Applications

The devices are designed for high-speed receiver and transmitter port protection:

- TVs, monitors
- DVD recorders and players
- Notebooks, main board graphics cards and ports
- Set-top boxes and game consoles



2. Pinning information

Table 1. Pinning

labic	e 1. Pinning							
Pin	Symbol	Description	Simplified outline	Graphic symbol				
IP42	IP4283CZ10-TBA (SOT1165-1)							
1	TMDS_CH1-	negative channel 1 ESD protection	[10] [9] 8 [7] [6]	1 2 4 5				
2	TMDS_CH1+	positive channel 1 ESD protection	1 2 3 4 5	A A A				
3	GND	ground	Transparent top view					
4	TMDS_CH2-	negative channel 2 ESD protection	DFN2510-10	3, 8				
5	TMDS_CH2+	positive channel 2 ESD protection		3, 0 001aai619				
6	n.c.	not connected						
7	n.c.	not connected						
8	GND	ground						
9	n.c.	not connected						
10	n.c.	not connected						
IP42	83CZ10-TBR (SOT	Γ1176-1)						
1	TMDS_CH1-	negative channel 1 ESD protection	10 9 8 7 6	1 2 4 5				
2	TMDS_CH1+	positive channel 1 ESD protection		 				
3	GND	ground	1 2 3 4 5 Transparent top view					
4	TMDS_CH2-	negative channel 2 ESD protection	DFN2510A-10	3, 8 _{001aai619}				
5	TMDS_CH2+	positive channel 2 ESD protection						
6	n.c.	not connected						
7	n.c.	not connected						
8	GND	ground						
9	n.c.	not connected						
10	n.c.	not connected						

 Table 1.
 Pinning ...continued

Pin	Symbol	Description	Simplified outline	Graphic symbol			
IP42	83CZ10-TT (SOT5	552-1)					
1	TMDS_CH1-	negative channel 1 ESD protection	10	1 2 4 5			
2	TMDS_CH1+	positive channel 1 ESD protection					
3	GND	ground					
4	TMDS_CH2-	negative channel 2 ESD protection		3,8			
5	TMDS_CH2+	positive channel 2 ESD protection		3, 0 001aai619			
6	n.c.	not connected	1 📗 📗 📗 5				
7	n.c.	not connected	TSSOP10				
8	GND	ground					
9	n.c.	not connected					
10	n.c.	not connected					

3. Ordering information

Table 2. Ordering information

Type number	Package				
	Name	Description	Version		
IP4283CZ10-TBA	DFN2510-10	plastic extremely thin small outline package; no leads; 10 terminals; body 1 \times 2.5 \times 0.5 mm	SOT1165-1		
IP4283CZ10-TBR	DFN2510A-10	plastic extremely thin small outline package; no leads; 10 terminals; body 1 \times 2.5 \times 0.5 mm	SOT1176-1		
IP4283CZ10-TT	TSSOP10	plastic thin shrink small outline package; 10 leads; body width 3 mm	SOT552-1		

4. Marking

Table 3. Marking codes

Type number	Marking code
IP4283CZ10-TBA	83
IP4283CZ10-TBR	83
IP4283CZ10-TT	4283

5. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{I}	input voltage		-0.5	+5.5	V
V _{ESD}	electrostatic discharge	IEC 61000-4-2, level 4	<u>[1]</u>		
	voltage	contact discharge	-8	+8	kV
		air discharge	-15	+15	kV
T _{stg}	storage temperature		-55	+125	°C
T _{amb}	ambient temperature		-40	+85	°C

^[1] All pins to ground.

6. Characteristics

Table 5. Characteristics

 $T_{amb} = 25$ °C unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{BR}	breakdown voltage	$I_{test} = 1 \text{ mA}$		6	-	9	V
I_{LR}	reverse leakage current	per TMDS channel; V = 3 V		-	-	1	μΑ
V _F	forward voltage	I _{test} = 1 mA		-	0.7	-	V
C _{line}	line capacitance	f = 1 MHz; $V_{bias} = 2.5 V$	<u>[1]</u>	-	0.6	-	pF
ΔC_{line}	line capacitance difference	f = 1 MHz; $V_{bias} = 2.5 V$	[1]	-	0.05	-	pF
C _{line(mutual)}	mutual line capacitance	f = 1 MHz; $V_{bias} = 2.5 V$	[1][2]	-	0.07	-	pF
r _{dyn}	dynamic resistance	surge	[3]				
		positive transient		-	8.0	-	Ω
		negative transient		-	0.85	-	Ω
V _{CL}	clamping voltage	positive transient; I _{PP} = 3.8 A	[3]	-	9.5	-	V
		negative transient; $I_{PP} = -2.8 \text{ A}$	[3]	-	-3.2	-	V

^[1] This parameter is guaranteed by design.

^[2] Between signal pin and pin n.c.

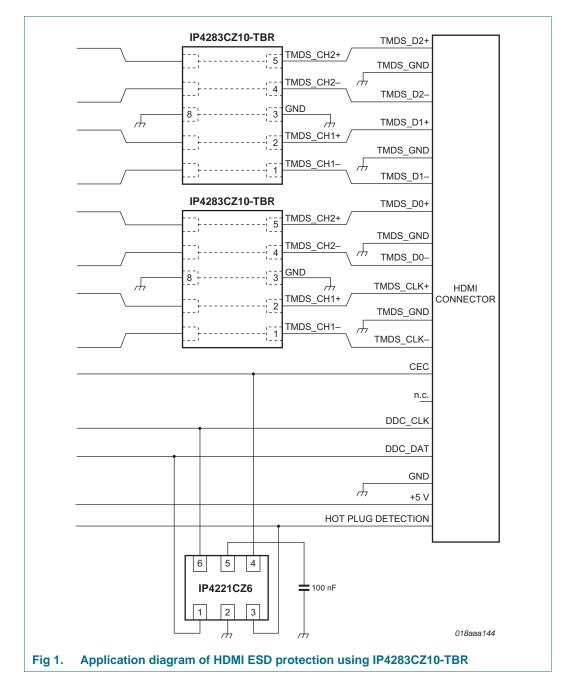
^[3] According to IEC 61000-4-5 (8/20 μ s).

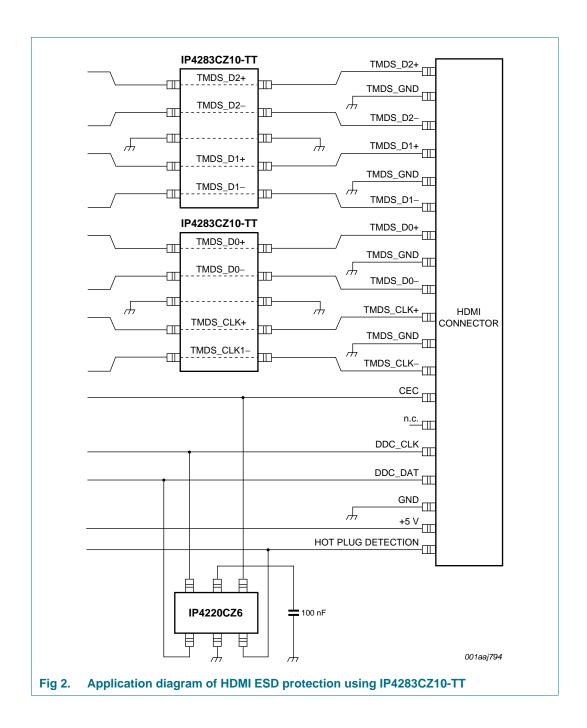
7. Application information

The devices are designed to provide high-level ESD protection for high-speed serial data buses such as HDMI, DisplayPort, eSATA and LVDS data lines.

When designing the Printed-Circuit Board (PCB), give careful consideration to impedance matching, and signal coupling.

Basic application diagrams for the ESD protection of an HDMI interface are shown in Figure 1 and $\underline{2}$.





8. Package outline

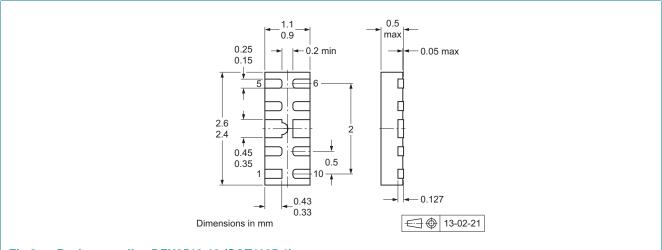


Fig 3. Package outline DFN2510-10 (SOT1165-1)

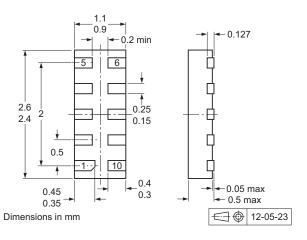


Fig 4. Package outline DFN2510A-10 (SOT1176-1)

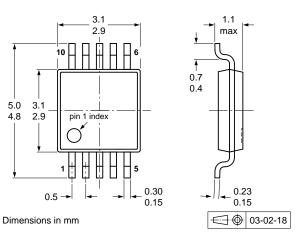
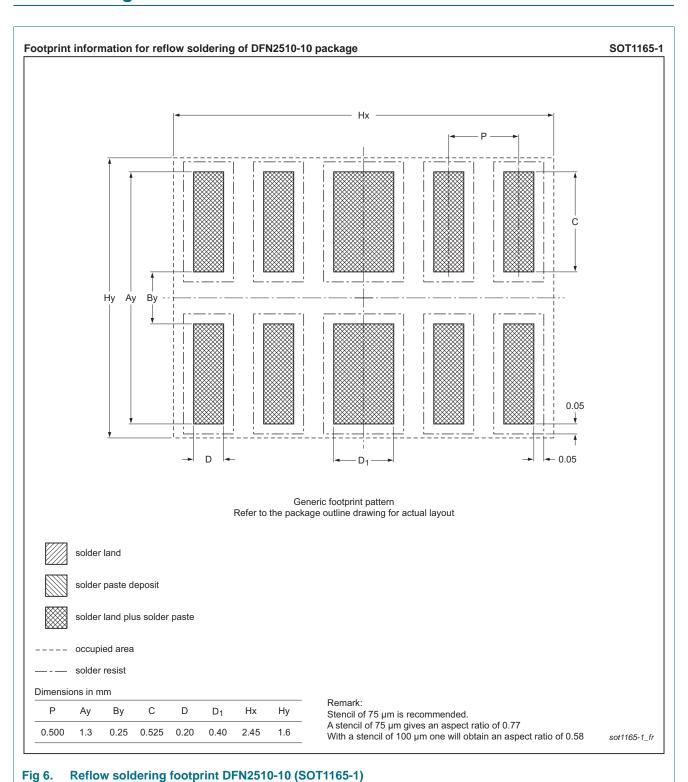
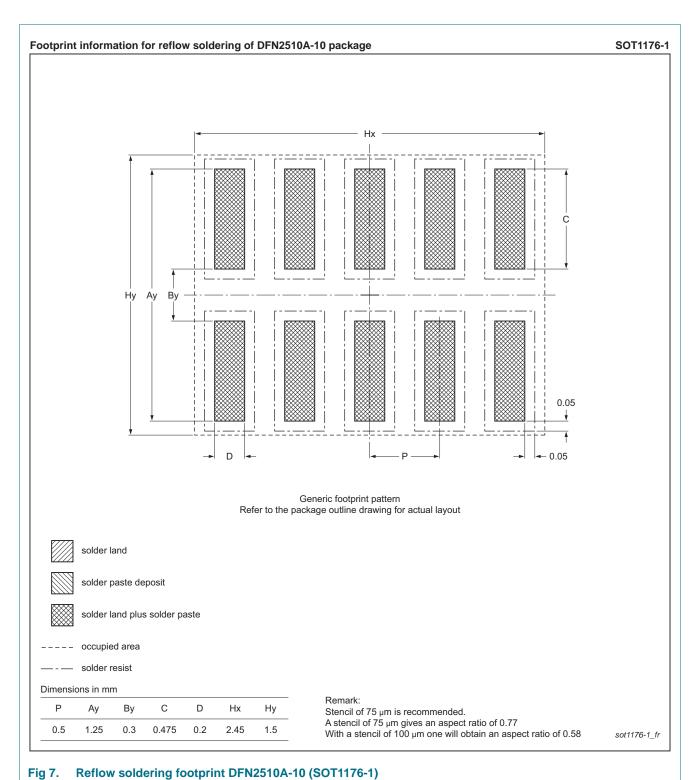


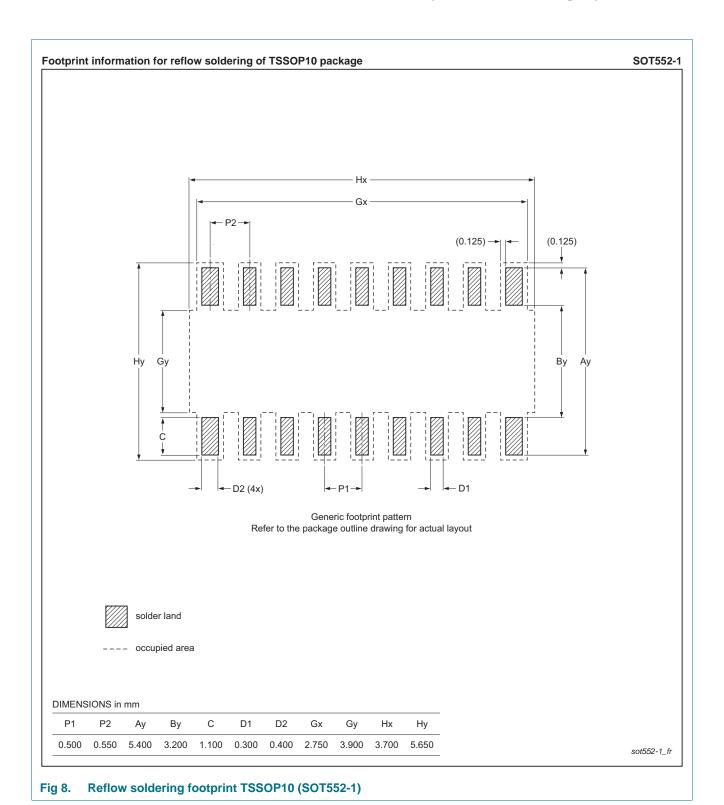
Fig 5. Package outline TSSOP10 (SOT552-1)

9. Soldering



rig 6. Renow soldering rootprint of N2310-10 (3011103-1)





IP4283CZ10_SER

10. Revision history

Table 6. Revision history

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Document ID	Release date	Data sheet status	Change notice	Supersedes				
IP4283CZ10_SER v.4	20130408	Product data sheet	-	IP4283CZ10_SER v.3				
Modifications:	Section 1.1	"General description": upd	ated					
	 Section 1.2 	"Features and benefits": up	pdated					
	 Section 2 "F 	Pinning information": update	ed					
	 Section 3 "0 	Ordering information": upda	ited					
	 <u>Table 5 "Characteristics"</u>: updated; r_{dyn} value corrected 							
	 Section 8 "Package outline": drawings replaced with minimized package outline drawings 							
	Section 9 "Soldering": updated							
	 Section 11 ° 	"Legal information": update	d					
IP4283CZ10_SER v.3	20110624	Product data sheet	-	IP4283CZ10_SER v.2				
IP4283CZ10_SER v.2	20100827	Product data sheet	-	IP4283CZ10 v.1				
IP4283CZ10 v.1	20090507	Product data sheet	-	-				

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11. Legal information

11.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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IP4283CZ10 series

ESD protection for ultra high-speed interfaces

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